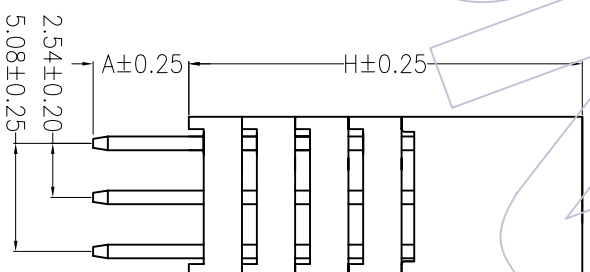
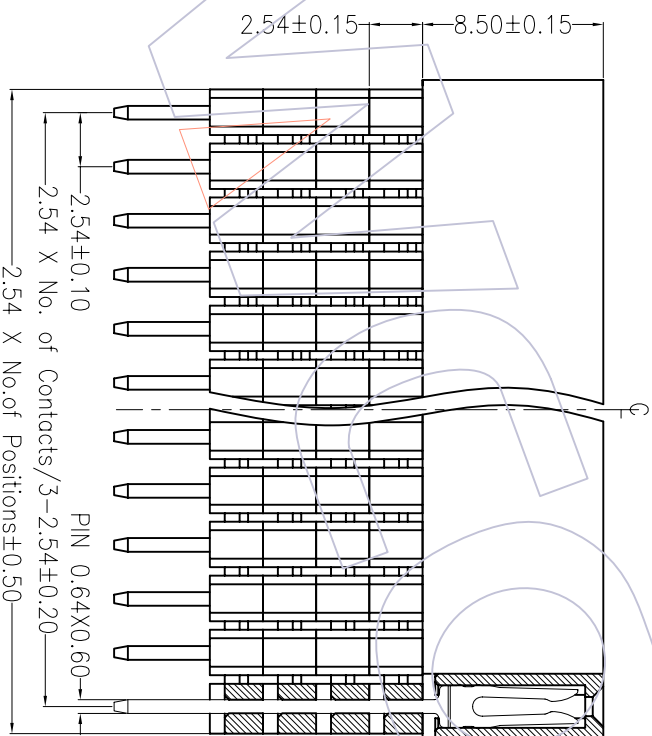
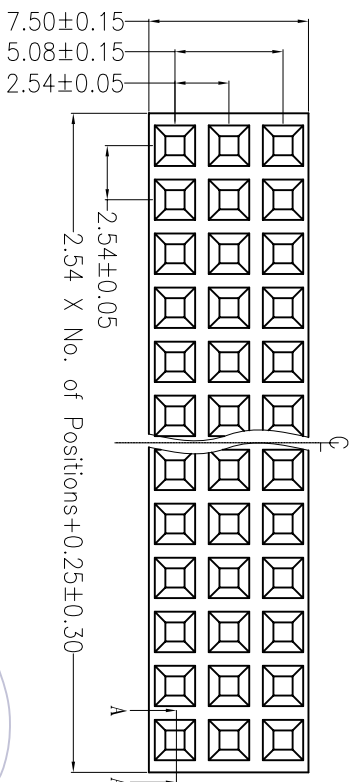


HSP

Recommended P.C.B Layout(TOP Side)
(PCB BOARD TOLERANCE±0.05)

NOTES:
Current Rating: 3.0AMP
Withstand Voltage: 500V AC/DC
Contact Resistance: 20mΩ Max
Insulation Resistance: 1000MΩ/Min
Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze or Brass
Contact plating: Au or Sn over Ni
Insulator Material: PBT or PA6T+30%G. F UL94V-0



Ordering Information

2185DN X - 2 XX S XX X YN X 1

Add number 1-4pcs
No. of Pins per ROW: 02-40PIN
Contact Plating: GP=Gold Flash, G1=3µ"Gold, G2=5µ"Gold, G3=10µ"Gold, G4=15µ"Gold, G5=50µ"Gold
S0=Gold FlashTm, S1=3µ"Gold/Tm, S2=5µ"Gold/Tm, S3=10µ"Gold/Tm, S4=15µ"Gold/Tm, S5=50µ"Gold/Tm, SN=Tm
Insulator: A=PBT, C=PA6T
Packing: T=Tube, A=Tray

SECTION A-A

Dimension antitheses List				
PART NO.	Add Number	Dim H	Dim A	Dim A
2185DN1-3XMSXXXXXX1	1	11.05	7.35	5.50
2185DN2-3XMSXXXXXX1	2	13.59	4.85	2.85
2185DN3-3XMSXXXXXX1	3	16.13	9.65	2.30
2185DN4-3XMSXXXXXX1	4	18.67	7.10	4.60

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	UNIT	PART NO.	TITLE:	CUSTOMER NO.
A1	08/03/28	增加两款DIP尺寸规格			X.X ±0.40	DESIGN	08.03.28	3:1	mm			
A0	08/03/13	NEW			X.XXX ±0.15	CHECK		A4	1/1			
					Angle ± 3'	APPROVE						

WCON 维峰五金电子有限公司
WAPE HARDWARE ELECTRONICS CO. LTD

SEE TABLE
FIG. 54 THREE ROWS 180° ADD HOUSING
H=8.5+HOUSING